JEPPE HINRICHS

Copenhagen, Denmark

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Employment History

2024-now	Firmware Engineer, Research & Development, Sensata Technologies
2021 - 2023	Graduate Researcher, Brain/Biomedical Microsystems Laboratory
2015 - 2017	Electrical Engineer, Development & Engineering, Welltec
2014 - 2015	Intern, Development & Engineering, Welltec

Education

2021 - 2023	Master of Science in Electrical Engineering, Korea Advanced Institute of Science &
	Technology
2021 - 2023	Master of Science in Electrical Engineering, Technical University of Denmark
2020	Research Student (Exchange), Tokyo Institute of Technology, Japan
2018 - 2020	Bachelor of Electrical Engineering, Technical University of Denmark

₹ Selected Projects

2024 Temperature sensor characterization and optimization | C++

- Conducted investigation of computational overhead and accuracy of Steinhart-Hart model
- Implemented optimized temperature calculation algorithm with binary search and linear interpolation
- Performance metrics on target increased by > 60% using improved algorithm compared to baseline

2023 Master Thesis | LTspice, Altium Designer, MATLAB, Xilinx Vivado, Python

- Title: Portable ultrasound system for blood velocity estimation
- Analysed research in devices for estimating the velocity of blood
- Designed system architecture of portable pulsed-wave Doppler ultrasound imaging device
- Implemented Zyng 7000 FPGA bitstream for ultrasound pulser control system
- Implemented MCU/FPGA interconnects and registers
- Synthesised ARM Cortex[©]-A9 based DSP with Fourier analysis

2020 Bachelor Thesis | LTspice, Altium Designer, MATLAB, Simulink

- Title: Influence of the output filter parasitic elements on a switch-mode audio amplifier
- Led a study into hitherto unexplored control theory of parasitic elements in electronic components
- Simulated and synthesized AIM class-D amplifier design
- Devised proposal of compensation strategy to improve control loops affected by parasitic elements

2017 Well Depth Acquisition | C++, Fusion 360, OrCAD

- Project lead on solution to enable universal telemetry capability during intervention and logging
- Managed a team of engineers in implementing an integration with existing flagship products
- Implemented mission-critical master and multi-slave half-duplex communications bus over RS485
- Conducted field testing in Germany, Netherlands, Malaysia, and the United States

* Skills

Languages Danish, English, German, Japanese, Korean

Coding </br>
C/C++, Python, Bash, LabVIEW, Assembly, Make

CAE/CAD

Altium Designer, KiCAD, OrCAD, LTspice, Qspice, Simulink, Fusion 360

★ Skills (continued)

Technologies

Linux, Git, RTOS, Xilinx Vivado, MATLAB, NI-DAQ

Misc.

Academic research, teaching, training, microcontrollers, computer hardware, exercise, music

Miscellaneous Experience

2023 Scholarship Award, from Siemens Foundation for research project funding at KAIST in South Korea

2020 Scholarship Award, from Scandinavia-Sasakawa Foundation for research project at Tokyo Institute of Technology in Japan